

SN54AHC574, SN74AHC574 OCTAL EDGE-TRIGGERED D-TYPE FLIP-FLOPS WITH 3-STATE OUTPUTS

SCLS244G – OCTOBER 1995 – REVISED JANUARY 2000

- **EPIC™ (Enhanced-Performance Implanted CMOS) Process**
- **Operating Range 2-V to 5.5-V V_{CC}**
- **3-State Outputs Drive Bus Lines Directly**
- **Latch-Up Performance Exceeds 250 mA Per JESD 17**
- **ESD Protection Exceeds 2000 V Per MIL-STD-883, Method 3015; Exceeds 200 V Using Machine Model ($C = 200$ pF, $R = 0$)**
- **Package Options Include Plastic Small-Outline (DW), Shrink Small-Outline (DB), Thin Very Small-Outline (DGV), Thin Shrink Small-Outline (PW), and Ceramic Flat (W) Packages, Ceramic Chip Carriers (FK), and Standard Plastic (N) and Ceramic (J) DIPs**

description

The 'AHC574 devices are octal edge-triggered D-type flip-flops that feature 3-state outputs designed specifically for driving highly capacitive or relatively low-impedance loads. These devices are particularly suitable for implementing buffer registers, I/O ports, bidirectional bus drivers, and working registers.

On the positive transition of the clock (CLK) input, the Q outputs are set to the logic levels of the data (D) inputs.

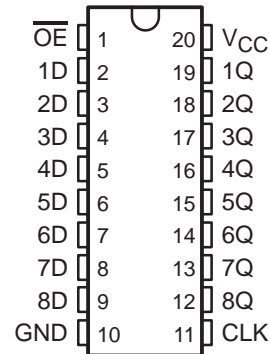
A buffered output-enable (\overline{OE}) input places the eight outputs in either a normal logic state (high or low) or the high-impedance state. In the high-impedance state, the outputs neither load nor drive the bus lines significantly. The high-impedance state and the increased drive provide the capability to drive bus lines without interface or pullup components.

\overline{OE} does not affect internal operations of the flip-flop. Old data can be retained or new data can be entered while the outputs are in the high-impedance state.

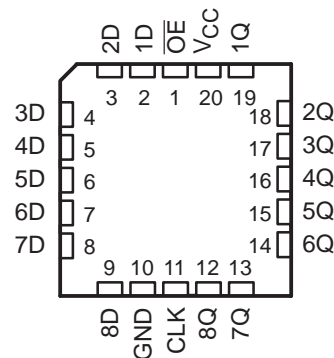
To ensure the high-impedance state during power up or power down, \overline{OE} should be tied to V_{CC} through a pullup resistor; the minimum value of the resistor is determined by the current-sinking capability of the driver.

The SN54AHC574 is characterized for operation over the full military temperature range of -55°C to 125°C . The SN74AHC574 is characterized for operation from -40°C to 85°C .

SN54AHC574 . . . J OR W PACKAGE
SN74AHC574 . . . DB, DGV, DW, N, OR PW PACKAGE
(TOP VIEW)



SN54AHC574 . . . FK PACKAGE
(TOP VIEW)



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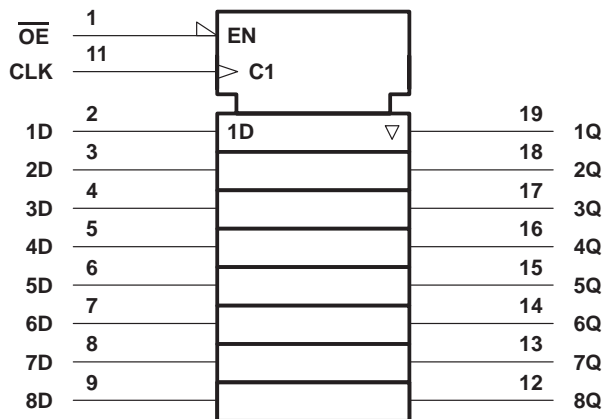
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FUNCTION TABLE
(each flip-flop)

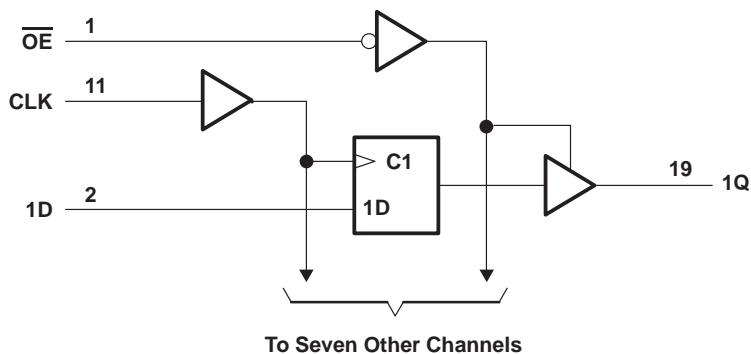
INPUTS			OUTPUT
\overline{OE}	CLK	D	Q
L	↑	H	H
L	↑	L	L
L	H or L	X	Q_0
H	X	X	Z

logic symbol†



† This symbol is in accordance with ANSI/IEEE Std 91-1984 and IEC Publication 617-12.

logic diagram (positive logic)



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absolute maximum ratings over operating free-air temperature range (unless otherwise noted)†

Supply voltage range, V_{CC}	–0.5 V to 7 V
Input voltage range, V_I (see Note 1)	–0.5 V to 7 V
Output voltage range, V_O (see Note 1)	–0.5 V to $V_{CC} + 0.5$ V
Input clamp current, I_{IK} ($V_I < 0$)	–20 mA
Output clamp current, I_{OK} ($V_O < 0$ or $V_O > V_{CC}$)	±20 mA
Continuous output current, I_O ($V_O = 0$ to V_{CC})	±25 mA
Continuous current through V_{CC} or GND	±75 mA
Package thermal impedance, θ_{JA} (see Note 2): DB package	70°C/W
DGV package	92°C/W
DW package	58°C/W
N package	69°C/W
PW package	83°C/W
Storage temperature range, T_{stg}	–65°C to 150°C

† Stresses beyond those listed under “absolute maximum ratings” may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under “recommended operating conditions” is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

- NOTES: 1. The input and output voltage ratings may be exceeded if the input and output current ratings are observed.
2. The package thermal impedance is calculated in accordance with JESD 51.

recommended operating conditions (see Note 3)

		SN54AHC574		SN74AHC574		UNIT
		MIN	MAX	MIN	MAX	
V_{CC}	Supply voltage	2	5.5	2	5.5	V
V_{IH}	High-level input voltage	$V_{CC} = 2$ V		1.5		V
		$V_{CC} = 3$ V		2.1		
		$V_{CC} = 5.5$ V		3.85		
V_{IL}	Low-level input voltage	$V_{CC} = 2$ V		0.5		V
		$V_{CC} = 3$ V		0.9		
		$V_{CC} = 5.5$ V		1.65		
V_I	Input voltage	0	5.5	0	5.5	V
V_O	Output voltage	0	V_{CC}	0	V_{CC}	V
I_{OH}	High-level output current	$V_{CC} = 2$ V		–50		μ A
		$V_{CC} = 3.3$ V ± 0.3 V		–4		mA
		$V_{CC} = 5$ V ± 0.5 V		–8		
I_{OL}	Low-level output current	$V_{CC} = 2$ V		50		μ A
		$V_{CC} = 3.3$ V ± 0.3 V		4		mA
		$V_{CC} = 5$ V ± 0.5 V		8		
$\Delta t/\Delta v$	Input transition rise or fall rate	$V_{CC} = 3.3$ V ± 0.3 V		100		ns/V
		$V_{CC} = 5$ V ± 0.5 V		20		
T_A	Operating free-air temperature	–55	125	–40	85	°C

NOTE 3: All unused inputs of the device must be held at V_{CC} or GND to ensure proper device operation. Refer to the TI application report, *Implications of Slow or Floating CMOS Inputs*, literature number SCBA004.



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electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

PARAMETER	TEST CONDITIONS	V _{CC}	T _A = 25°C			SN54AHC574		SN74AHC574		UNIT
			MIN	TYP	MAX	MIN	MAX	MIN	MAX	
V _{OH}	I _{OH} = -50 μA	2 V	1.9	2		1.9		1.9	V	
		3 V	2.9	3		2.9		2.9		
		4.5 V	4.4	4.5		4.4		4.4		
	I _{OH} = -4 mA	3 V	2.58			2.48		2.48		
	I _{OH} = -8 mA	4.5 V	3.94			3.8		3.8		
V _{OL}	I _{OL} = 50 μA	2 V			0.1		0.1	0.1	V	
		3 V			0.1		0.1	0.1		
		4.5 V			0.1		0.1	0.1		
	I _{OL} = 4 mA	3 V			0.36		0.5	0.44		
	I _{OL} = 8 mA	4.5 V			0.36		0.5	0.44		
I _I	V _I = V _{CC} or GND	0 V to 5.5 V			±0.1		±1*	±1	μA	
I _{OZ}	V _O = V _{CC} or GND	5.5 V			±0.25		±2.5	±2.5	μA	
I _{CC}	V _I = V _{CC} or GND, I _O = 0	5.5 V			4		40	40	μA	
C _i	V _I = V _{CC} or GND	5 V			3	10		10	pF	
C _o	V _O = V _{CC} or GND	5 V			3				pF	

* On products compliant to MIL-PRF-38535, this parameter is not production tested at V_{CC} = 0 V.

timing requirements over recommended operating free-air temperature range, V_{CC} = 3.3 V ± 0.3 V (unless otherwise noted) (see Figure 1)

		T _A = 25°C		SN54AHC574		SN74AHC574		UNIT
		MIN	MAX	MIN	MAX	MIN	MAX	
t _w	Pulse duration, CLK high or low	5		5		5		ns
t _{su}	Setup time, data before CLK↑	3.5		3.5		3.5		ns
t _h	Hold time, data after CLK↑	1.5		1.5		1.5		ns

timing requirements over recommended operating free-air temperature range, V_{CC} = 5 V ± 0.5 V (unless otherwise noted) (see Figure 1)

		T _A = 25°C		SN54AHC574		SN74AHC574		UNIT
		MIN	MAX	MIN	MAX	MIN	MAX	
t _w	Pulse duration, CLK high or low	5		5		5		ns
t _{su}	Setup time, data before CLK↑	3		3		3		ns
t _h	Hold time, data after CLK↑	1.5		1.5		1.5		ns



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**switching characteristics over recommended operating free-air temperature range,
V_{CC} = 3.3 V ± 0.3 V (unless otherwise noted) (see Figure 1)**

PARAMETER	FROM (INPUT)	TO (OUTPUT)	LOAD CAPACITANCE	T _A = 25°C			SN54AHC574		SN74AHC574		UNIT	
				MIN	TYP	MAX	MIN	MAX	MIN	MAX		
f _{max}			C _L = 15 pF	80*	125*		65*		65		MHz	
			C _L = 50 pF	50	75		45		45			
t _{PLH}	CLK	Q	C _L = 15 pF		8.5*	13.2*	1*	15.5*	1	15.5	ns	
t _{PHL}					8.5*	13.2*	1*	15.5*	1	15.5		
t _{PZH}	\overline{OE}	Q	C _L = 15 pF		8.2*	12.8*	1*	15*	1	15	ns	
t _{PZL}					8.2*	12.8*	1*	15*	1	15		
t _{PHZ}	\overline{OE}	Q	C _L = 15 pF		8.5*	13*	1*	15*	1	15	ns	
t _{PLZ}					8.5*	13*	1*	15*	1	15		
t _{PLH}	CLK	Q	C _L = 50 pF		11	16.7		1	19	1	19	ns
t _{PHL}					11	16.7		1	19	1	19	
t _{PZH}	\overline{OE}	Q	C _L = 50 pF		10.7	16.3		1	18.5	1	18.5	ns
t _{PZL}					10.7	16.3		1	18.5	1	18.5	
t _{PHZ}	\overline{OE}	Q	C _L = 50 pF		11	15		1	17	1	17	ns
t _{PLZ}					11	15		1	17	1	17	
t _{sk(o)}			C _L = 50 pF			1.5**				1.5	ns	

* On products compliant to MIL-PRF-38535, this parameter is not production tested.

** On products compliant to MIL-PRF-38535, this parameter does not apply.

**switching characteristics over recommended operating free-air temperature range,
V_{CC} = 5 V ± 0.5 V (unless otherwise noted) (see Figure 1)**

PARAMETER	FROM (INPUT)	TO (OUTPUT)	LOAD CAPACITANCE	T _A = 25°C			SN54AHC574		SN74AHC574		UNIT	
				MIN	TYP	MAX	MIN	MAX	MIN	MAX		
f _{max}			C _L = 15 pF	130*	180*		110*		110		MHz	
			C _L = 50 pF	85	115		75		75			
t _{PLH}	CLK	Q	C _L = 15 pF		5.6*	8.6*	1*	10*	1	10	ns	
t _{PHL}					5.6*	8.6*	1*	10*	1	10		
t _{PZH}	\overline{OE}	Q	C _L = 15 pF		5.9*	9*	1*	10.5*	1	10.5	ns	
t _{PZL}					5.9*	9*	1*	10.5*	1	10.5		
t _{PHZ}	\overline{OE}	Q	C _L = 15 pF		5.5*	9*	1*	10.5*	1	10.5	ns	
t _{PLZ}					5.5*	9*	1*	10.5*	1	10.5		
t _{PLH}	CLK	Q	C _L = 50 pF		7.1	10.6		1	12	1	12	ns
t _{PHL}					7.1	10.6		1	12	1	12	
t _{PZH}	\overline{OE}	Q	C _L = 50 pF		7.4	11		1	12.5	1	12.5	ns
t _{PZL}					7.4	11		1	12.5	1	12.5	
t _{PHZ}	\overline{OE}	Q	C _L = 50 pF		7.1	10.1		1	11.5	1	11.5	ns
t _{PLZ}					7.1	10.1		1	11.5	1	11.5	
t _{sk(o)}			C _L = 50 pF			1**				1	ns	

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noise characteristics, $V_{CC} = 5\text{ V}$, $C_L = 50\text{ pF}$, $T_A = 25^\circ\text{C}$ (see Note 4)

PARAMETER	SN74AHC574		UNIT
	MIN	MAX	
$V_{OL(P)}$ Quiet output, maximum dynamic V_{OL}		0.8	V
$V_{OL(V)}$ Quiet output, minimum dynamic V_{OL}		-0.8	V
$V_{OH(V)}$ Quiet output, minimum dynamic V_{OH}	4.2		V
$V_{IH(D)}$ High-level dynamic input voltage	3.5		V
$V_{IL(D)}$ Low-level dynamic input voltage		1.5	V

NOTE 4: Characteristics are for surface-mount packages only.

operating characteristics, $V_{CC} = 5\text{ V}$, $T_A = 25^\circ\text{C}$

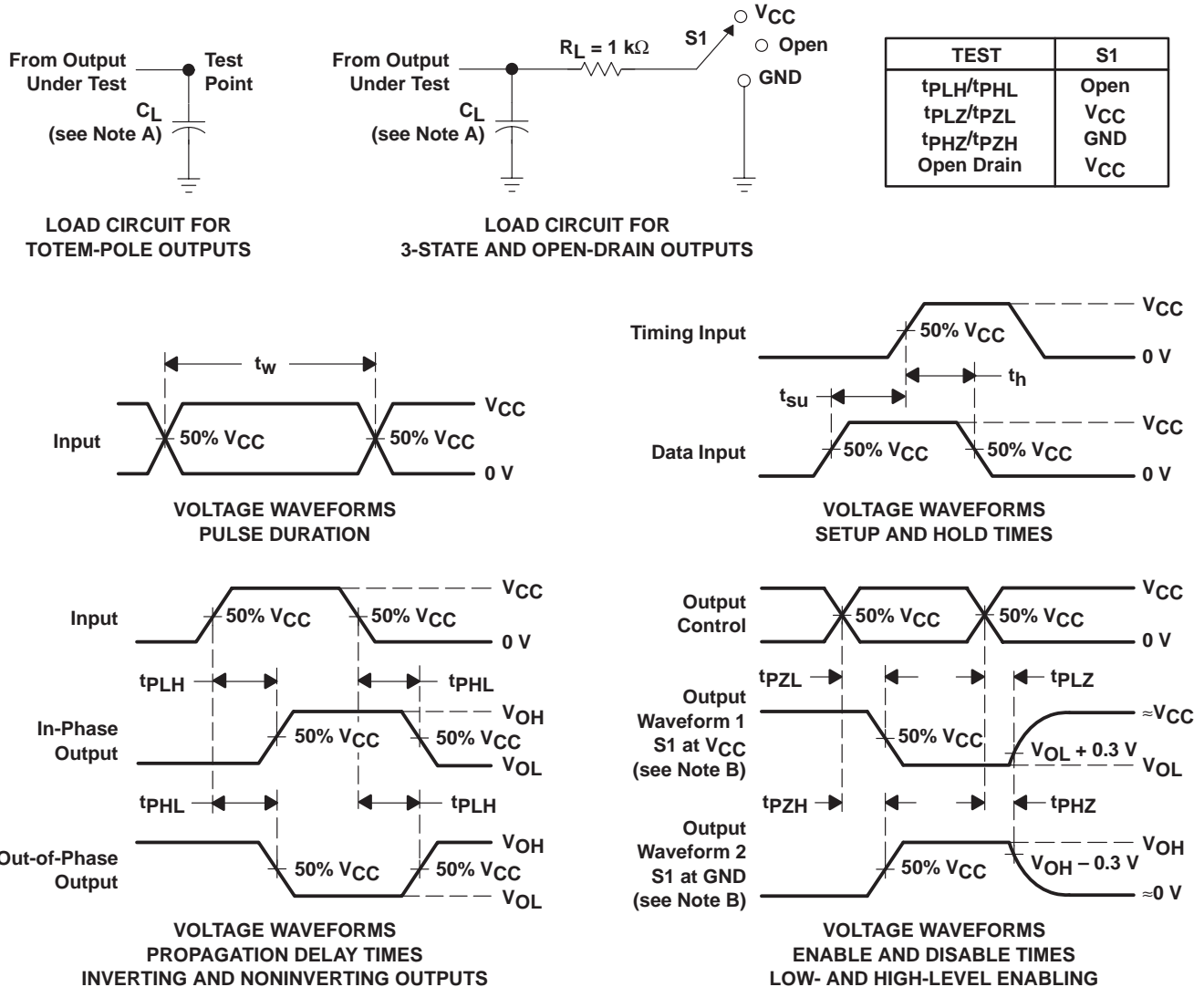
PARAMETER	TEST CONDITIONS	TYP	UNIT
C_{pd} Power dissipation capacitance	No load, $f = 1\text{ MHz}$	28	pF



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PARAMETER MEASUREMENT INFORMATION



- NOTES: A. C_L includes probe and jig capacitance.
 B. Waveform 1 is for an output with internal conditions such that the output is low except when disabled by the output control. Waveform 2 is for an output with internal conditions such that the output is high except when disabled by the output control.
 C. All input pulses are supplied by generators having the following characteristics: $PRR \leq 1\text{ MHz}$, $Z_O = 50\ \Omega$, $t_r \leq 3\text{ ns}$, $t_f \leq 3\text{ ns}$.
 D. The outputs are measured one at a time with one input transition per measurement.

Figure 1. Load Circuit and Voltage Waveforms

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